

Electronic Patent Application Fee Transmittal

Application Number:	10518538			
Filing Date:	30-Dec-2004			
Title of Invention:	THERMOPLASTIC RESIN AND FORMED PRODUCT			
First Named Inventor/Applicant Name:	Akio Nodera			
Filer:	Marvin Jay Spivak/Saida Polat			
Attorney Docket Number:	263152US0PCT			
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Basic Filing:				
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Miscellaneous-Filing:				
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Patent-Appeals-and-Interference:				
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Total in USD (\$)				1700